NST857BDP6T5G

Dual General Purpose Transistor

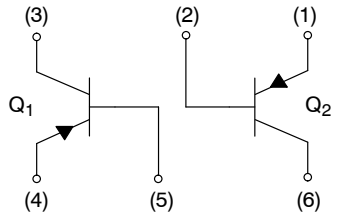
The NST857BDP6T5G device is a spin−off of our popular SOT−23/SOT−323/SOT−563 three−leaded device. It is designed for general purpose amplifier applications and is housed in the SOT−963 six−leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low−power surface mount applications where board space is at a premium.

Features

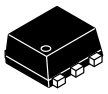
- h_{FE}, 220−475
- Low $V_{CE(sat)}$, ≤ 0.3 V
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- This is a Pb−Free Device

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NST857BDP6T5G



SOT−963
CASE 527AD

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector − Emitter Voltage		V_{CEO}	−45	Vdc
Collector − Base Voltage		V_{CBO}	−50	Vdc
Emitter − Base Voltage		V_{EBO}	−6.0	Vdc
Collector Current − Continuous		I_C	−100	mAdc
Electrostatic Discharge	HBM MM	ESD Class	2 B	

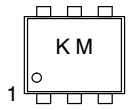
THERMAL CHARACTERISTICS

Characteristic (Single Heated)	Symbol	Max	Unit
Total Device Dissipation T_A = 25°C Derate above 25°C (Note 1)	P_D	240 1.9	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	520	°C/W
Total Device Dissipation T_A = 25°C Derate above 25°C (Note 2)	P_D	280 2.2	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	446	°C/W
Characteristic (Dual Heated) (Note 3)	**Symbol**	**Max**	**Unit**
Total Device Dissipation T_A = 25°C Derate above 25°C (Note 1)	P_D	350 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	357	°C/W
Total Device Dissipation T_A = 25°C Derate above 25°C (Note 2)	P_D	420 3.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	297	°C/W
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR−4 @ 100 mm^2, 1 oz. copper traces, still air.
2. FR−4 @ 500 mm^2, 1 oz. copper traces, still air.
3. Dual heated values assume total power is sum of two equally powered channels.

MARKING DIAGRAM



K = Device Code
M = Date Code

ORDERING INFORMATION

Device	Package	Shipping†
NST857BDP6T5G	SOT−963 (Pb−Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (I_C = −10 mA)	$V_{(BR)CEO}$	−45	–	–	V
Collector – Emitter Breakdown Voltage (I_C = −10 μA, V_{EB} = 0)	$V_{(BR)CES}$	−50	–	–	V
Collector – Base Breakdown Voltage (I_C = −10 μA)	$V_{(BR)CBO}$	−50	–	–	V
Emitter – Base Breakdown Voltage (I_E = −1.0 μA)	$V_{(BR)EBO}$	−5.0	–	–	V
Collector Cutoff Current (V_{CB} = −30 V) (V_{CB} = −30 V, T_A = 150°C)	I_{CBO}	– –	– –	−15 −4.0	nA μA
ON CHARACTERISTICS					
DC Current Gain (I_C = −10 μA, V_{CE} = −5.0 V) (I_C = −2.0 mA, V_{CE} = −5.0 V)	h_{FE}	 – 220	 150 290	 – 475	–
Collector – Emitter Saturation Voltage (I_C = −10 mA, I_B = −0.5 mA) (I_C = −100 mA, I_B = −5.0 mA)	$V_{CE(sat)}$	 – –	 – –	 −0.3 −0.7	V
Base – Emitter Saturation Voltage (I_C = −10 mA, I_B = −0.5 mA) (I_C = −100 mA, I_B = −5.0 mA)	$V_{BE(sat)}$	 – –	 −0.7 −0.9	 – –	V
Base – Emitter On Voltage (I_C = −2.0 mA, V_{CE} = −5.0 V) (I_C = −10 mA, V_{CE} = −5.0 V)	$V_{BE(on)}$	 −0.6 –	 – –	 −0.75 −0.82	V
SMALL−SIGNAL CHARACTERISTICS					
Current – Gain – Bandwidth Product (I_C = −10 mA, V_{CE} = −5.0 Vdc, f = 100 MHz)	f_T	100	–	–	MHz
Output Capacitance (V_{CB} = −10 V, f = 1.0 MHz)	C_{obo}	–	–	4.5	pF
Input Capacitance (V_{EB} = −0.5 V, f = 1.0 MHz)	C_{ibo}	–	–	10	pF
Noise Figure (I_C = −0.2 mA, V_{CE} = −5.0 Vdc, R_S = 2.0 kΩ, f = 1.0 kHz, BW = 200 Hz)	NF	–	–	10	dB

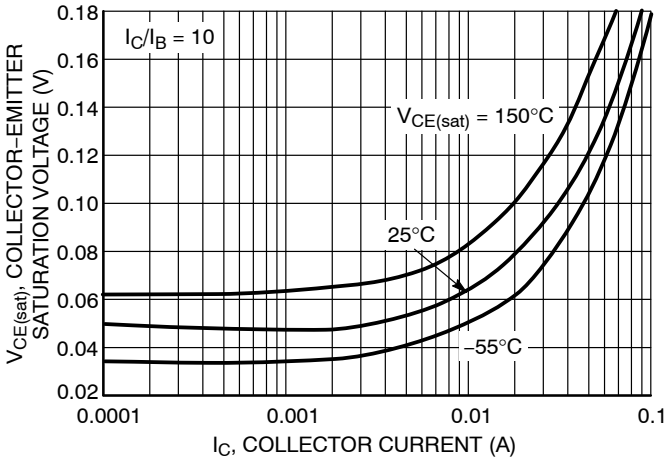


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

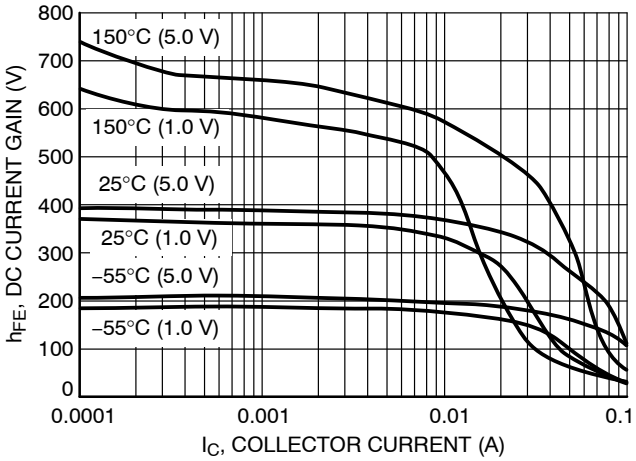


Figure 2. DC Current Gain vs. Collector Current

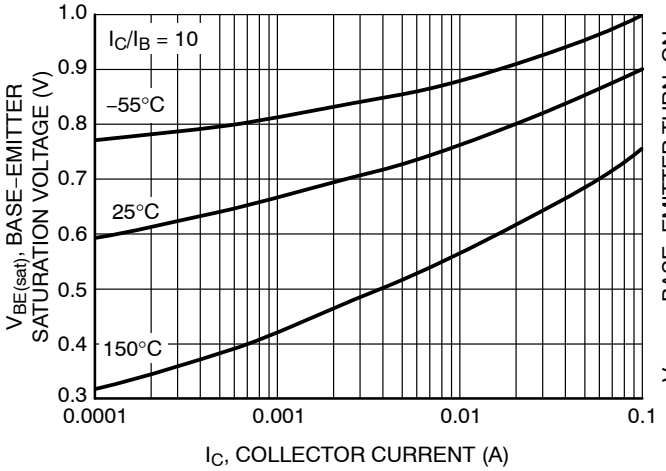


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

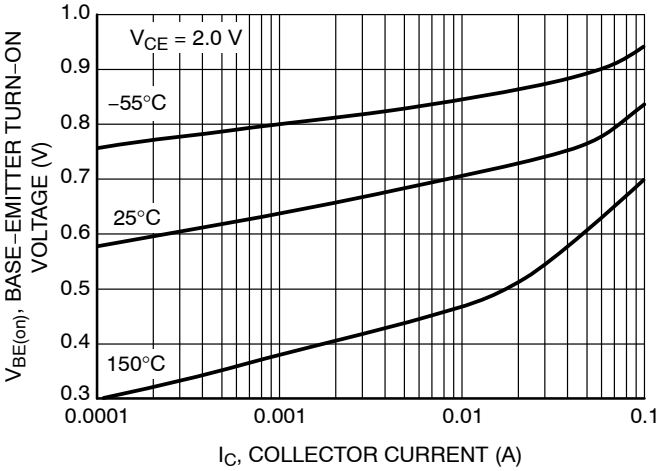


Figure 4. Base Emitter Turn−On Voltage vs. Collector Current

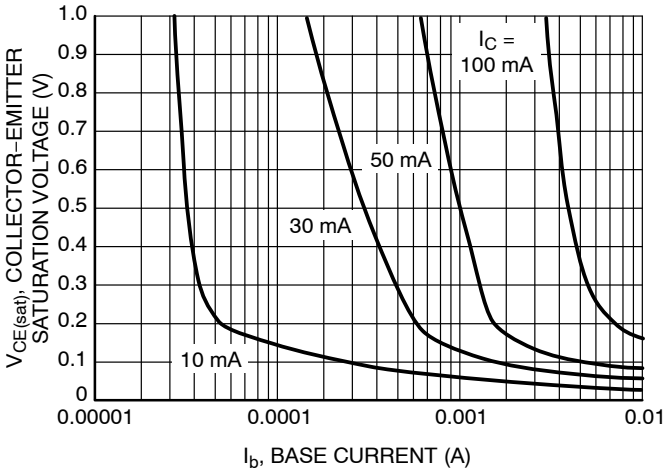


Figure 5. Saturation Region

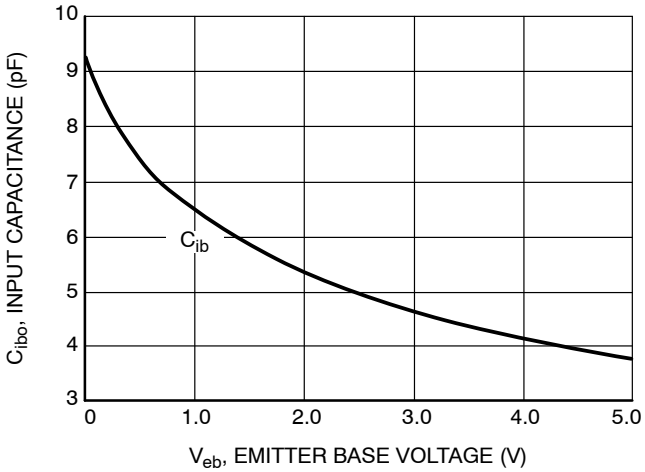


Figure 6. Input Capacitance

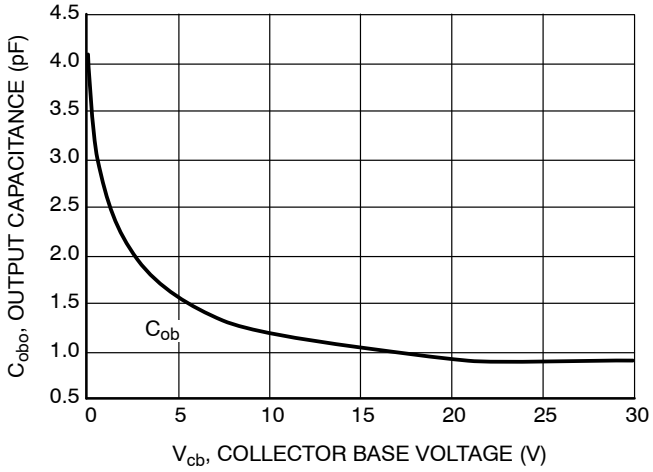
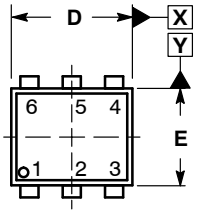


Figure 7. Output Capacitance

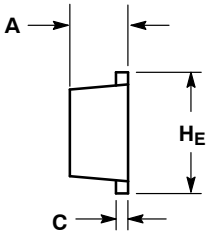
NST857BDP6T5G

PACKAGE DIMENSIONS

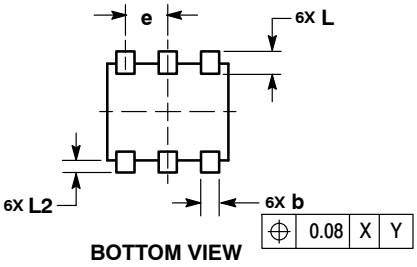
SOT−963
CASE 527AD
ISSUE E



TOP VIEW



SIDE VIEW

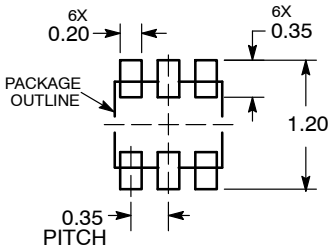


BOTTOM VIEW

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS		
DIM	MIN	NOM	MAX
A	0.34	0.37	0.40
b	0.10	0.15	0.20
C	0.07	0.12	0.17
D	0.95	1.00	1.05
E	0.75	0.80	0.85
e		0.35 BSC	
H_E	0.95	1.00	1.05
L		0.19 REF	
L2	0.05	0.10	0.15

RECOMMENDED MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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